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Change in menu Project

Designator	Quantity	Value	Description	PackageReference	PartNumber	Manufacturer	Alternate PartNumber	Alternate Manufacturer
IPC81	1		Printed Circuit Board		XX###	Any	-	-
C1	1	150uF	CAP, AL, 150uF, 100V, +/-20%, 0.17 ohm, SMD	SMT Radial J16	EEV-FK2A151M	Panasonic	-	-
C2, C40, C43, C79	4	1000pF	CAP, CERM, 1000 pF, 50 V, +/- 10%, X8R, 0603	0603	C1608X8R1H102K	TDK	-	-
C3, C10, C31, C44, C51, C70	6	0.1uF	CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603	0603	C1608X7R1H104K	TDK	-	-
C4, C32, C45, C71	4	2200pF	CAP, CERM, 2200pF, 50V, +/-10%, X7R, 0603	0603	C0603C222K5RACTU	Kemet	-	-
C5, C30, C46, C69	4	1uF	CAP, CERM, 1uF, 16V, +/-10%, X7R, 0603	0603	GRM188R71C105KA12D	MuRata	-	-
C6, C7, C8, C9, C26, C27, C28, C29, C47, C48, C49, C50, C65, C66, C67, C68, C82, C83, C84, C85, C86, C87, C88, C89, C90, C91, C92, C93, C94, C95, C96, C97	32	22uF	CAP, CERM, 22uF, 25V, +/-10%, X7R, 1210	1210	GRM32ER71E226KE15L	MuRata	-	-
C12, C23, C53, C62	4	0.1uF	CAP, CERM, 0.1uF, 100V, +/-10%, X7R, 0603	0603	GRM188R72A104KA35D	MuRata	-	-
C13	1	1000pF	CAP, CERM, 1000 pF, 100 V, +/- 5%, X7R, 0603	0603	06031C102JAT2A	AVX	-	-
C14, C15, C34, C35, C54, C55, C73, C74	8	150uF	CAP, TA, 150uF, 16V, +/-20%, 0.05 ohm, SMD	7.3x2.8x4.3mm	16TQC150MYF	Panasonic	-	-
C17, C37, C56, C75	4	22uF	CAP, CERM, 22uF, 25V, +/-10%, X6S, 1210	1210	GRM32EC81E226KE15L	MuRata	-	-
C20	1	0.047uF	CAP, CERM, 0.047 uF, 25 V, +/- 5%, X7R, 0603	0603	06033C473JAT2A	AVX	-	-
C21, C41, C42, C60	4	0.1uF	CAP, CERM, 0.1uF, 100V, +/-10%, X7R, 0805	0805	C2012X7R2A104K	TDK	-	-
C22, C61	2	100pF	CAP, CERM, 100pF, 50V, +/-5%, C0G/NP0, 0603	0603	06035A101JAT2A	AVX	-	-
C24	1	Not Used	CAP, CERM, xxxF, xxV, [TempCo], xx%, [PackageReference]	0603	DNP2	Used in BOM report	-	-
C25, C64	2	22pF	CAP, CERM, 22pF, 50V, +/-5%, C0G/NP0, 0603	0603	C1608C0G1H220J	TDK	-	-
C80	1	0.1uF	CAP, CERM, 0.1uF, 16V, +/-10%, X7R, 0603	0603	C0603C104K4RACTU	Kemet	-	-
C81	1	1000pF	CAP, CERM, 1000 pF, 50 V, +/- 10%, C0G/NP0, 0603	0603	06035A102KAT2A	AVX	-	-
D1, D2, D3, D6, D7, D10, D11, D12, D15, D16	10	0.6V	Diode, Schottky, 100V, 0.15A, SOD-123	SOD-123	BAT46W-7-F	Diodes Inc.	-	-
D4, D8, D13, D17	4	0.7V	Diode, Schottky, 30V, 0.2A, SOD-323	SOD-323	BAT54WS-7-F	Diodes Inc.	-	-
D19	1	5.6V	Diode, Zener, 5.6V, 200mW, SOD-323	SOD-323	MMSZ5232BS-7-F	Diodes Inc.	-	-
H1, H2, H5, H6	4		Standoff, Hex, 0.5"L #4-40 Nylon	Standoff	1902C	Keystone	-	-
H3, H4, H7, H8	4		Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead	Screw	NY PMS 440 0025 PH	B&F Fastener Supply	-	-
J1, J2, J3, J4, J5, J6	6	Triple	Terminal, Turret, TH, Triple	Keystone1598-2	1598-2	Keystone	Equivalent	Any
J7, J8, J9, J10, J11, J12	6	50 ohm	Connector, RF Jack, Vertical, Gold, SMD	A-1JB	A-1JB	Amphenol	-	-
L1, L2, L3, L4	4	10uH	Inductor, Shielded E Core, Ferrite, 10 uH, 23.4 A, 0.00186 ohm, SMD	29.7x15.36x27.94mm	SER2915H-103KL	Coilcraft	-	-
LBL1	1		Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll	PCB Label 0.650"H x 0.200"W	THT-14-423-10	Brady	-	-
Q1, Q3, Q7, Q9, Q13, Q15, Q19, Q21	8	40V	MOSFET, N-CH, 40V, 180A, DDPAK-7	DDPAK-7	IPB180N04S4-H0	Infineon Technologies	-	None
Q4, Q10, Q16, Q22	4	0.38V	TRANS BIPO PNP 30V 1A SOT-323	SOT-323	2DB1694-7	Diodes Inc.	-	-
Q25	1	0.2V	Transistor, NPN, 40V, 0.2A, SOT-23	SOT-23	MMBT3904	Fairchild Semiconductor	-	-
R1, R2, R21, R23, R28, R29, R39, R41	8	100	RES, 100, 1%, 0.1 W, 0603	0603	CRCW0603100RFKEA	Vishay-Dale	-	-
R3, R19, R30, R37	4	182k	RES, 182k ohm, 1%, 0.1W, 0603	0603	CRCW0603182KFKEA	Vishay-Dale	Equivalent	Any
R4, R31	2	0	RES, 0 ohm, 5%, 0.1W, 0603	0603	CRCW0603000Z0EA	Vishay-Dale	-	-
R5, R14	2	10.0k	RES, 10.0k ohm, 1%, 0.1W, 0603	0603	CRCW060310K0FKEA	Vishay-Dale	-	-
R6	1	60.4k	RES, 60.4 k, 1%, 0.1 W, 0603	0603	CRCW060360K4FKEA	Vishay-Dale	-	-
R7, R32	2	1.00	RES, 1.00 ohm, 1%, 0.125W, 0805	0805	CRCW08051R00FNEA	Vishay-Dale	-	-
R8	1	2.49k	RES, 2.49k ohm, 1%, 0.1W, 0603	0603	CRCW06032K49FKEA	Vishay-Dale	-	-
R10	1	16.2k	RES, 16.2k ohm, 1%, 0.063W, 0402	0402	CRCW040216K2FKED	Vishay-Dale	-	-
R11	1	1.02k	RES, 1.02k ohm, 1%, 0.063W, 0402	0402	CRCW04021K02FKED	Vishay-Dale	-	-
R12	1	3.40k	RES, 3.40 k, 1%, 0.1 W, 0603	0603	CRCW06033K40FKEA	Vishay-Dale	-	-
R15, R22, R34, R40	4	0.001	RES, 0.001, 1%, 1 W, 2010	2010	PMR50HZPFV1L00	Rohm	-	-
R16, R35	2	49.9k	RES, 49.9 k, 1%, 0.1 W, 0603	0603	CRCW060349K9FKEA	Vishay-Dale	-	-
R17	1	49.9	RES, 49.9 ohm, 1%, 0.1W, 0603	0603	CRCW060349R9FKEA	Vishay-Dale	-	-
R24, R25, R26, R27, R42, R43	6	49.9	RES, 49.9 ohm, 1%, 0.125W, 0805	0805	CRCW080549R9FKEA	Vishay-Dale	Equivalent	Any
R44	1	4.7k	RES, 4.7k ohm, 5%, 0.1W, 0603	0603	CRCW06034K70JNEA	Vishay-Dale	-	-
R45	1	200	RES, 200, 1%, 0.1 W, 0603	0603	RC0603FR-07200RL	Yageo America	-	-
R46	1	3.48k	RES, 3.48 k, 1%, 0.1 W, 0603	0603	CRCW06033K48FKEA	Vishay-Dale	-	-
R50, R52, R54, R56, R59, R60, R61, R62	8	0	RES, 0 ohm, 5%, 0.063W, 0402	0402	CRCW0402000Z0ED	Vishay-Dale	-	-

Designator	Quantity	Value	Description	PackageReference	PartNumber	Manufacturer	Alternate PartNumber	Alternate Manufacturer
T1, T2	2	50A	Terminal 50A Lug	CB35-36-CY	CB35-36-CY	Panduit	Equivalent	Any
T3, T4	2	90A	Terminal 90A Lug	CB70-14-CY	CB70-14-CY	Panduit	Equivalent	Any
TP1, TP3	2	Red	Test Point, TH, Multipurpose, Red	Keystone5010	5010	Keystone	Equivalent	Any
TP2, TP4, TP7	3	Black	Test Point, TH, Multipurpose, Black	Keystone5011	5011	Keystone	Equivalent	Any
TP5, TP6	2	White	Test Point, TH, Multipurpose, White	Keystone5012	5012	Keystone	Equivalent	Any
U1, U2	2		IC CTRL SYNC BUCK DUAL 32-LLP	SQA32A	LM5119PSQE/NOPB	Texas Instruments		
U3	1		CMOS Timer, 8-pin Mini SOIC	MUA08A	LMC555CMM	Texas Instruments		
U4	1	SN74LVC1G04DBVR	IC, Single Gate Inverter		SN74LVC1G04DBVR	Texas Instruments		
C11, C33, C52, C72	0	2700pF	CAP, CERM, 2700pF, 100V, +/-5%, X7R, 0805	0805	08051C272JAT2A	AVX	-	-
C16, C18, C19, C36, C38, C39, C57, C58, C59, C76, C77, C78	0	22uF	CAP, CERM, 22uF, 25V, +/-10%, X6S, 1210	1210	GRM32EC81E226KE15L	MuRata		
C63	0	Not Used	CAP, CERM, xxxF, xxV, [TempCo], xx%, [PackageReference]	0603	DNP2	Used in BOM report	-	-
D20, D21, D22, D23	0	0.7V	Diode, Schottky, 30V, 0.2A, SOD-323	SOD-323	BAT54WS-7-F	Diodes Inc.	-	-
D24, D25, D26, D27	0	60V	Diode, Schottky, 60V, 2A, SMB	SMB	MBRS260T3G	ON Semiconductor		
FID1, FID2, FID3	0		Fiducial mark. There is nothing to buy or mount.	Fiducial	N/A	N/A		
R9	0	Not Used	RES, xxx ohm, x%, xW, [PackageReference]	0603	DNP1	Used in BOM report	-	-
R13, R20, R33, R38	0	1.00	RES, 1.00 ohm, 1%, 0.25W, 1206	1206	CRCW12061R00FNEA	Vishay-Dale		
R18, R36, R63	0	0	RES, 0 ohm, 5%, 0.1W, 0603	0603	CRCW06030000Z0EA	Vishay-Dale		
R47, R48, R49, R51, R53, R55, R57, R58	0	4.7k	RES, 4.7k ohm, 5%, 0.063W, 0402	0402	CRCW04024K70JNED	Vishay-Dale		

Notes:

Unless otherwise noted in the Alternate PartNumber and/or Alternate Manufacturer columns, all parts may be substituted with equivalents.

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